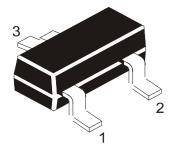
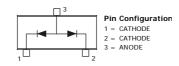


SILICON PLANAR DUAL SWITCHING DIODES





BAW74

SOT-23 Formed SMD Package

Marking BAW74 - JD

High-Speed Switching Dual Diodes, Common Anode

ABSOLUTE MAXIMUM RATINGS

DESCRIPTION	SYMBOL	VALUE	UNIT
Maxium Repetitive Reverse Voltage	V _{RRM}	50	V
Average Rectified Forward Current	I _{F(AV)}	200	mA
Power Dissipation T _a =25 ^o C	P _D	350	mW
Non Repetitive Peak Forward Surge Current	I _{FSM}		
Pulse Width=1s		1	А
Pulse Width=1ms		2	А
Storage Temperature Range	T _{stg}	- 55 to +150	°C
Operating Junction Temperature	Tj	150	О°

THERMAL RESISTANCE

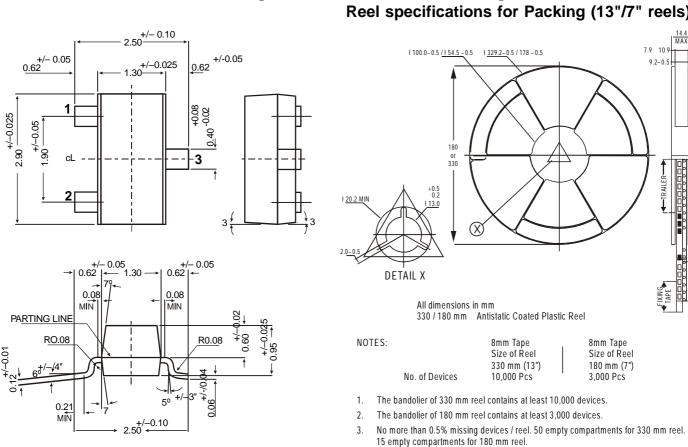
Junction to Ambient in free air R _{th (j-a)} 357 °C/W
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ELECTRICAL CHARACTERISTICS (T_a=25° C unless specified otherwise)

DESCRIPTION	SYMBOL	L TEST CONDITION		MAX	UNIT
Breakdown Voltage	V _R	I _R = 100μA	50		V
Forward Voltage	*V _F	I _F = 100mA			V
Reverse Current	*I _R	V _R =50V		100	nA
		V _{R=} 50V, T _a =150°C		100	μΑ
Total Capacitance	CT	V _R =0V, f=1MHz		2	pF
Reverse Recovery Time	t _{rr}	$I_F=I_R=10mA$, $I_{RR}=1mA$, $R_L=100\Omega$		4	ns

*Pulse Test : Pulse Width =300ms, Duty Cycle=2%

SOT-23 Formed SMD Package



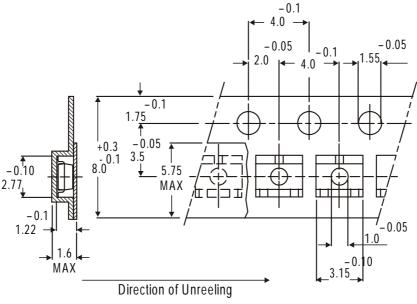
SOT-23 Formed SMD Package

consecutive devices. 5. The carrier tape (leader) starts with at least 75 empty positions (equivalent to 330 mm). In order to fix the carrier tape a self adhesive tape of 20 to 50 mm is applied. At the end of the bandolier at least 40 empty positions (equivalent to 160 mm) are there.

Three consecutive empty places might be found provided this gap is followed by 6

Tape Specification for SOT-23 Surface Mount Device

4.



All dimensions in mm

SOT-23 Package Reel Information Reel specifications for Packing (13"/7" reels)

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
SOT-23 T&R	3K/reel		3" x 7.5" x 7.5" 9" x 9" x 9"	12.0K 51.0K	17" x 15" x 13.5" 19" x 19" x 19"	192.0K 408.0K	12 kgs 28 kgs
	10K/reel	415 gm/10K pcs	13" x 13" x 0.5"	10.0K	17" x 15" x 13.5"	300.0K	16 kgs

Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

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